

AEM10900 Evaluation Board User Guide

Description

The AEM10900 evaluation kit (EVK) is a printed circuit board (PCB) featuring all the required components to operate the AEM10900 integrated circuit (IC) in WLCSP16-pin package.

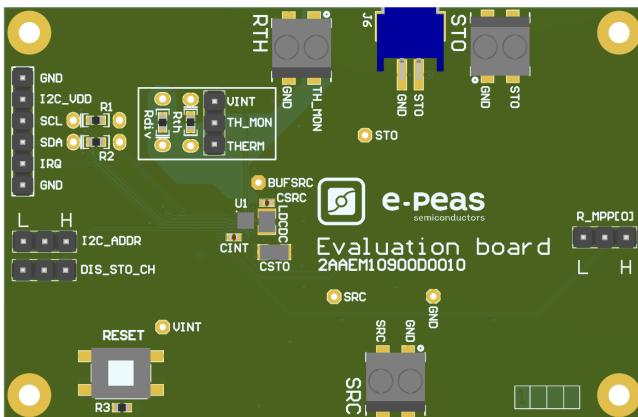
The AEM10900 evaluation board allows users to test the e-peas IC and analyze its performances in a laboratory-like setting or in product mock-ups.

It allows easy connections to an energy harvester (e.g. a single element PV cell) and a storage element. It also provides all the configuration access to set the device in any of the modes described in the datasheet. The control and status signals are available on standard pin headers or through an I²C bus communication, allowing users to override preconfigured board settings through host MCU and evaluate the IC performances.

The AEM10900 EVK is a plug and play, intuitive and efficient tool to optimize the AEM10900 configuration, allowing users to design a highly efficient subsystem for the desired target application. Component replacement and operating mode switching is convenient and easy.

More detailed information about AEM10900 features can be found in the datasheet.

Appearance



Features

Two-way screw terminals

- Source of energy (DC).
- Energy storage element (battery).
- Thermistor used for thermal monitoring.

2-pin "Shrouded Header"

- Alternative connector for the storage element.

3-pin headers

- Maximum power point ratio (R_MPP) configuration.
- Battery charge disable configuration.
- Thermal monitoring configuration.
- AEM10900 I²C address.

6-pin header

- I²C communication pins.
- Storage status

Applications

Wearable Electronics	Keyboards
Remote Control Units	Electronic Shelf Labels
Smart Buildings	Indoor Sensors

Evaluation Kit Information

Part Number	Dimensions
2AAEM10900D0010	76 mm x 49 mm

Device Information

Part Number	Package	Body size
10AEM10900D0000	WLCSP16	2x2mm

1. Connections Diagram

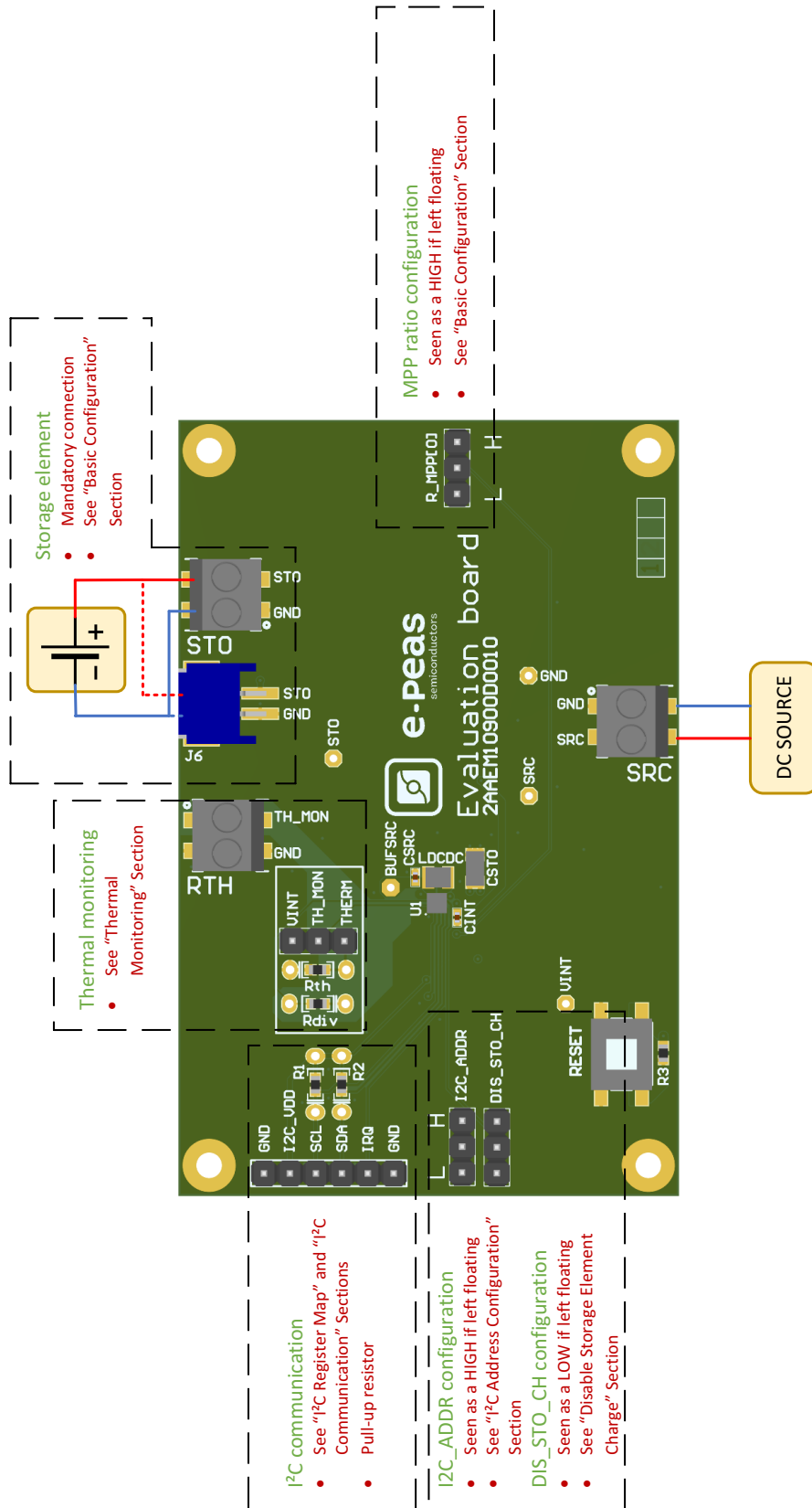


Figure 1: Connection diagram

2. Signals Description

NAME	FUNCTION	CONNECTION	
		If used	If not used
Power signals			
SRC	Connection to the harvested energy source.	Connect the source element.	Can be left floating.
STO	Connection to the energy storage element.	Cannot be left floating, voltage must always be above 2.5 V.	
I ² C_VDD	Connection to I ² C voltage supply.	Connect to I ² C supply.	Connect to GND.
VINT	AEM Internal voltage supply.		
BUFSRC	AEM connection to a capacitor buffering the boost converter input (no connector on EVK).		
Configuration signals			
R_MPP[0]	Configuration of the MPP ratio.	Connect jumper.	Read as HIGH if left floating.
TH_MON	Configuration of the thermal monitoring.	Connect a thermistor.	Connect to VINT.
Control signals			
DIS_STO_CH	Disabling pin for the storage charging.	Connect jumper (see Section 3.5.2).	Read as LOW if left floating.
I²C signals			
SDA	Bidirectional data line.	Connect to host I ² C bus.	Connect I ² C_VDD to GND (SDA and SCL will be pulled down by R ₁ and R ₂).
SCL	Unidirectional serial clock.		
IRQ	Interrupt request.	Connect to host GPIO.	Leave floating.
I ² C_ADDR	Configuration bit for I ² C address.	Connect jumper (see Section 3.5.1).	Read as HIGH if left floating.

Table 1: Pin description

3. General Considerations

3.1. Safety Information

Always perform these steps in the following order:

1. Reset the board: push the “RESET” switch during 5 seconds minimum.
2. Completely configure the PCB (jumpers/resistors):
 - Source configuration.
 - Battery configuration.
 - Mode configuration.
 - Thermal monitoring configuration.
3. Connect I2C_VDD:
 - To GND if I²C is not used (SDA and SCL will also be connected to GND through their pull up resistors).
 - To a power supply if I²C is used (1.5 V to 5 V).
4. Connect the storage elements on STO with a voltage higher than 2.5 V.
5. Connect the source to the SRC connector (open circuit voltage lower than 3 V).

3.2. Basic Configurations

Configuration	Availability Through Pins		MPPT ratio
	I ² C Interface ^a	Configuration pins ^b	
R_MPP[3:0]			V_{MPP} / V_{OC}
LLLL	yes	no	Reserved
LLLH	yes	no	90%
LLHL	yes	no	65%
LLHH	yes	no	60%
LHLL	yes	no	85%
LHLH	yes	no	75%
LHHL	yes	yes	70%
LHHH	yes	yes	80%
HLLL	yes	no	35%
HLLH	yes	no	50%

Table 2: Configuration of R_{MPPT}

- a. For I²C configuration, R_MPP[3:0] value is set thanks to the MPPTCFG[3:0] register.
 b. Only R_MPP[0] setting is available by GPIO configuration (R_MPP[3:1] = LHH in that case).

Configuration	Availability Through Pins		MPP Timing	
	I ² C Interface ^a	Configuration pins ^b	Sampling duration T_{VOC} [ms]	Sampling period T_{MPPT} [ms]
T_MPP[2:0]				
LLL	yes	no	2	64
LLH	yes	no	256	16384
LHL	yes	no	64	4096
LHH	yes	no	8	1024
HLL	yes	no	4	256
HLH	yes	no	2	128
HHL	yes	no	4	512
HHH	yes	yes	2	256

Table 3: Configuration of T_{MPPT}

- a. For I²C configuration, T_MPP[2:0] value is set thanks to the MPPTCFG[6:4] register (see Table 5).
 b. T_MPP[2:0] configuration only available by I²C interface (default configuration is HHH).

Configuration	Configuration availability		Storage Element Threshold Voltage		Battery type
	I ² C Interface	Configuration pins	V _{OVCH}	V _{OVDIS}	
STO_CFG[2:0] ^a					
LLL	yes	no	4.50 V	3.30 V	NiCd 3 cells
LLH	yes	no	4.00 V	2.80 V	Tadrian TLI1020A
LHL	yes	no	3.63 V	2.80 V	LiFePO4
LHH	yes	no	3.90 V	2.80 V	Tadrian HCL1020
HLL	yes	no	3.80 V	2.50 V	LIC
HLH	yes	no	3.90 V	3.01 V	Li-ion (long life)
HHL	yes	no	4.35 V	3.01V	LiPo
HHH	yes	yes	4.12 V	3.01 V	Li-ion/solid-state/ NiMH

Table 4: Usage of STO_CFG[2:0]

a. STO_CFG[2:0] configuration only available by I²C interface (default configuration is HHH).

3.3. I²C Register Map

Address	Name	Bit	Field Name	Access	RESET	Description
0x00	VERSION	[7:0]	VERSION	R	-	Version number
0x01	MPPTCFG	[3:0]	RATIO	R/W	0x07 (80%)	MPPT ratios
		[6:4]	TIMING	R/W	0x07 (2ms/256ms)	MPPT timings
0x02	VOVDIS	[5:0]	THRESH	R/W	0x2D (3.05V)	Overdischarge level of the storage element
0x03	VOVCH	[5:0]	THRESH	R/W	0x33 (4.1V)	Overcharge level of the storage element
0x04	TEMPCOLD	[7:0]	THRESH	R/W	0x8F (0°C)	Cold temperature level
0x05	TEMPHOT	[7:0]	THRESH	R/W	0x2F (45°C)	Hot temperature level
0x06	PWR	[0:0]	KEEPALEN	R/W	0x01	Keep-alive enable
		[1:1]	HPEN	R/W	0x01	High-power mode enable
		[2:2]	TMONEN	R/W	0x01	Temperature monitoring enable
		[3:3]	STOCHDIS	R/W	0x00	Battery charging disable
0x07	SLEEP	[0:0]	EN	R/W	0x01	Sleep mode enable
		[3:1]	THRESH	R/W	0x00	Sleep threshold
0x08	RSVD	[2:0]	-	R/W	-	This register can be written in but it will have no effect
0x09	APM	[0:0]	EN	R/W	0x00	APM enable
		[1:1]	RSVD1	R/W	0x00	Write 0x01 when APM is used.
		[3:2]	RSVD2	R/W	0x00	Write 0x00 when APM is used.
0x0A	IRQEN	[0:0]	I2CRDY	R/W	0x01	IRQ serial interface ready enable
		[1:1]	VOVDIS	R/W	0x00	IRQ STO OVDIS enable
		[2:2]	VOVCH	R/W	0x00	IRQ STO OVCH enable
		[3:3]	SLPTHRESH	R/W	0x00	IRQ SRC LOW enable
		[4:4]	TEMP	R/W	0x00	IRQ temperature enable
		[5:5]	APMDONE	R/W	0x00	IRQ APM done enable
		[6:6]	APMERR	R	0x00	IRQ APM error enable
0x0B	CTRL	[0:0]	UPDATE	R/W	0x00	Load I ² C registers configuration
		[2:2]	SYNCBUSY	R	0x00	Synchronization busy flag
0x0C	IRQFLG	[0:0]	I2CRDY	R	0x00	IRQ serial interface ready flag
		[1:1]	VOVDIS	R	0x00	IRQ STO OVDIS flag
		[2:2]	VOVCH	R	0x00	IRQ STO OVCH flag
		[3:3]	SLPTHRESH	R	0x00	IRQ SRC LOW flag
		[4:4]	TEMP	R	0x00	IRQ temperature flag
		[5:5]	APMDONE	R	0x00	IRQ APM done flag
		[6:6]	APMERR	R	0x00	IRQ APM error flag
0x0D	STATUS	[1:1]	VOVDIS	R	0x00	Status STO OVDIS
		[2:2]	VOVCH	R	0x00	Status STO OVCH
		[3:3]	SLPTHRESH	R	0x00	Status SRC LOW
		[4:4]	TEMP	R	0x00	Status temperature
		[6:6]	CHARGE	R	0x00	Status STO Charge
0x0E	APM0	[7:0]	DATA	R	0x00	APM data 0

Table 5: Register summary



Address	Name	Bit	Field Name	Access	RESET	Description
0x0F	APM1	[7:0]	DATA	R	0x00	APM data 1
0x10	APM2	[7:0]	DATA	R	0x00	APM data 2
0x11	TEMP	[7:0]	DATA	R	0x00	Temperature data
0x12	STO	[7:0]	DATA	R	0x00	Battery voltage
0x13	SRC	[7:0]	DATA	R	0x00	SRC ADC value
0xE0	PN0	[7:0]	DATA	R	0X30	Part number 0 data
0xE1	PN1	[7:0]	DATA	R	0X30	Part number 1 data
0xE2	PN2	[7:0]	DATA	R	0X39	Part number 2 data
0xE3	PN3	[7:0]	DATA	R	0X30	Part number 3 data
0xE4	PN4	[7:0]	DATA	R	0X31	Part number 4 data

Table 5: Register summary

3.4. I²C Communication

All information about the I²C communication is available in the AEM10900 datasheet, “System configuration” Section.

I²C_VDD must be connected to an external power supply which voltage is within the 1.5 V to 5.0 V range. On the Evaluation Board, 1 kΩ pull-up on SDA and SCL (R1 and R2) to I²C_VDD are provided.

In case one or more configurations are set by I²C communication, none of the configuration pins (GPIOs) will be taken into account anymore. Thus, applying the default values to any registers that have not been explicitly configured by I²C.

3.5. Advanced Configurations

A complete description of the system constraints and configurations is available in Section “System configuration” of the AEM10900 datasheet.

3.5.1. I²C Address Configuration

The device I²C address can be configured thanks to the I²C_ADDR pin by placing a jumper to connect:

- I²C_ADDR to H for 0x41.
- I²C_ADDR to L for 0x40.

If left floating, the I²C_ADDR pin is read as HIGH.

3.5.2. Mode Configuration

DIS_STO_CH

Enabling/disabling battery charging can be done by setting a jumper on the corresponding 3-pin header.

- Use a jumper to connect the DIS_STO_CH to H to disable the charge of the storage element.
- Use a jumper to connect the DIS_STO_CH to L to enable the charge of the storage element.

3.5.3. Thermal Monitoring

The thermal monitoring feature protects the battery by disabling the battery charging when ambient temperature is outside a specified range. The higher and lower thresholds are configurable using the I²C communication (see datasheet).

- Place a jumper between TH_MON and VINT to disable the feature.
- Place a jumper between TH_MON and THERM to enable the feature.

4. Functional Tests

This section presents a few simple tests that allow users to understand the functional behavior of the AEM10900. To avoid damaging the board, follow the procedure found in Section 3.1. If a test has to be restarted, make sure to properly reset the system to obtain reproducible results.

The measurements use the following equipment:

- Two Source Measurement Units (SMU, four-quadrant power supply).
- One 2-channel oscilloscope.

The following functional tests were made using the following setup:

- EVK jumpers configuration:

4.1. Cold-start

The following test allows users to observe the minimum voltage required to coldstart the AEM10900. To prevent current leakage caused by the probe impedance, users should avoid probing any unnecessary node. Make sure to properly reset the board to observe the cold-start behavior.

Setup

- Place oscilloscope probe on **SRC**.
- Referring Figure 1, follow steps 1 to 5 explained in Section 3.1.
- **SRC**: SMU set as 20 μ A current source with 0.3 V voltage compliance.
- **STO**: SMU as 3.0 V voltage source with 100 μ A current compliance.

- **R_MPP[0]** = L (70 %).
- **V_OVDIS** = 3.01 V (default).
- **V_OVCH** = 4.12 V (default).
- **DIS_STO_CH** = L.
- Place the jumper to connect **TH_MON** with **VINT**.
- Place a jumper to connect **I2C_VDD** and **GND** if the I²C communication is not used.

Users can adapt the setup to match the use case system as long as the input limitations are respected, as well as the minimum storage voltage and cold-start constraints (see “Introduction” Section of AEM10900 datasheet).

Observations and measurements

- **SRC** voltage clamped at the cold-start voltage during the cold-start phase and then regulated at the selected MPPT percentage of **V_{OC}** configured thanks to **R_{MPPT}** when cold start is over. The duration of the cold-start phase decreases as the input power increases. Select the input power accordingly to be able to observe the cold-start phase.
- **STO**: SMU starts absorbing current sourced by the **STO** pin once the cold-start phase is completed.

4.2. I²C Communication

This test allows users to change a configuration through the I²C communication.

Setup

- Place the oscilloscope probe on SRC.
- Referring to Figure 1, follow steps 1 to 5 explained in Section 3.1. Configure the board in the desired state and start the system.
- Connect **I2C_VDD** to the I²C supply (between 1.8 V and 5.5 V).
- Write '0010 0011' (0x23) on the MPPTCFG register (0x01):
 - VMPP / VOC = 60 %.
 - 64 ms V OC sampling duration.

4.3. Efficiency

This test allows users to reproduce the efficiency graphs of the boost converter (see "DCDC Conversion Efficiency" Section in the AEM10900 datasheet).

Setup

- Referring to Figure 1, follow steps 1 to 5 explained in Section 3.1. Configure the board in the desired state and start the system (see Section 3.1)
- **STO**: connect SMU configured as a 4.7 V voltage source with a 100 mA current compliance.
- **SRC**: connect SMU configured as a source current with a voltage compliance of 1.0 V to ensure the AEM10900 coldstarts.

Manipulations

- 4 s VOC sampling period.

- Write '1' to the CTRL register (0x0B) to load the I²C register configuration (at startup the AEM10900 loads its configurations from the pins settings)

Observations and measurements

- **SRC**: observe that the voltage regulation switches to 60% of the open circuit voltage VOC as defined by the **SRC** SMU voltage compliance, when the register value is loaded.
- **SRC**: observe that the timing between two MPP evaluation is 4 s and the duration of the MPP is 64 ms.

- **STO**: set the SMU to the desired voltage, between **V_{OVDIS}** and **V_{OVCH}**. Make sure the SMU integration time is as long as possible.

- **SRC**: sweep the voltage compliance of the SMU from 0.12 V to 1.5 V to let the AEM10900 set VMPP according to the MPP ratio.

Observations and measurements

- For each data point of the **SRC** voltage sweep, note the **SRC** SMU voltage and current, as well as the **STO** SMU voltage and current. Repeat the measurement for each data point a copious number of times to ensure capturing current peaks.
- The efficiency η in percent is computed by applying the following formula:

$$\eta = 100 \cdot \frac{V_{STO} \cdot I_{STO}}{V_{SRC} \cdot I_{SRC}}$$

5. DCDC Conversion Efficiency

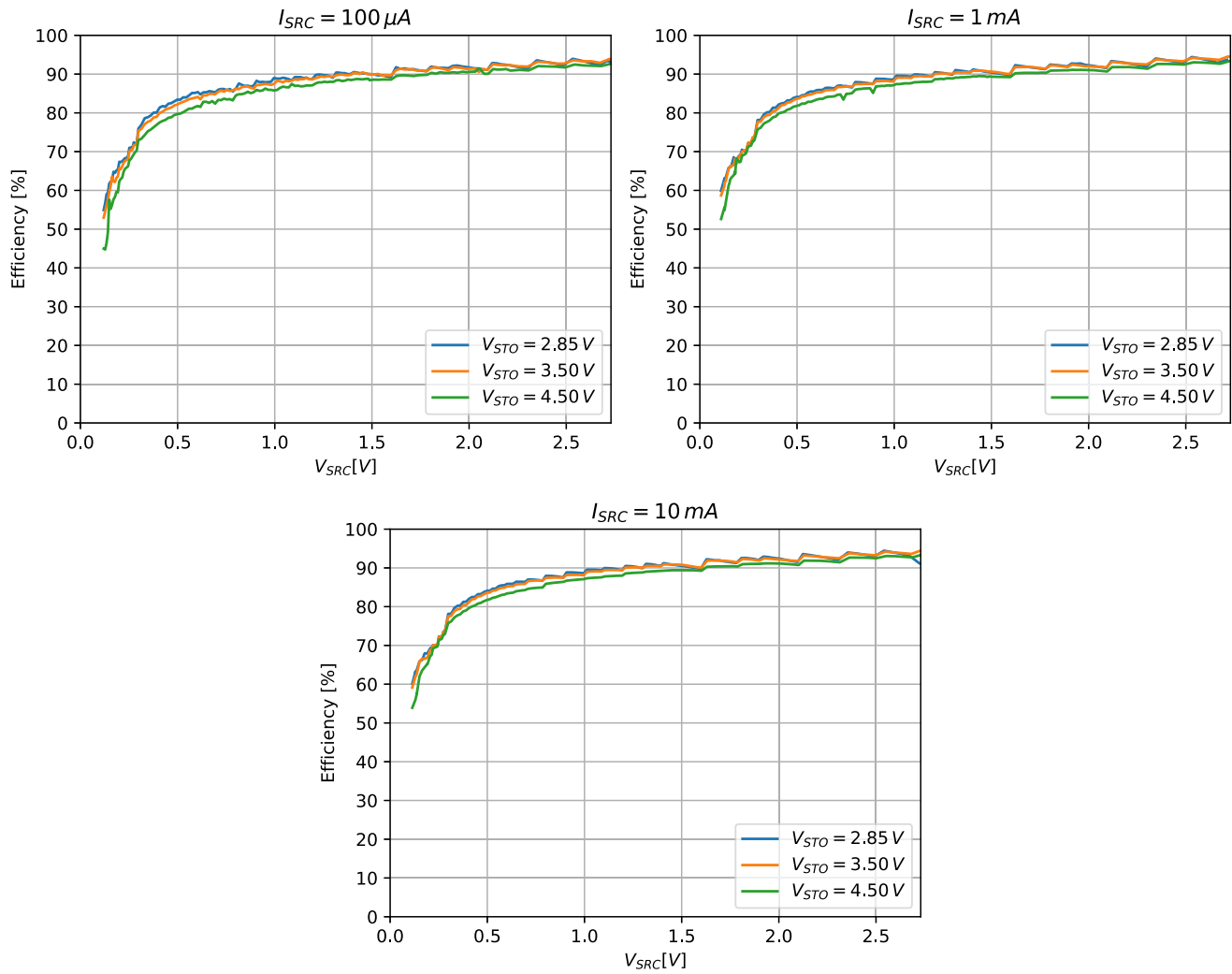


Figure 2: AEM010900 DCDC conversion efficiency (LDCDC: TDK VLS252012HBX-6R8M-1)

6. Schematics

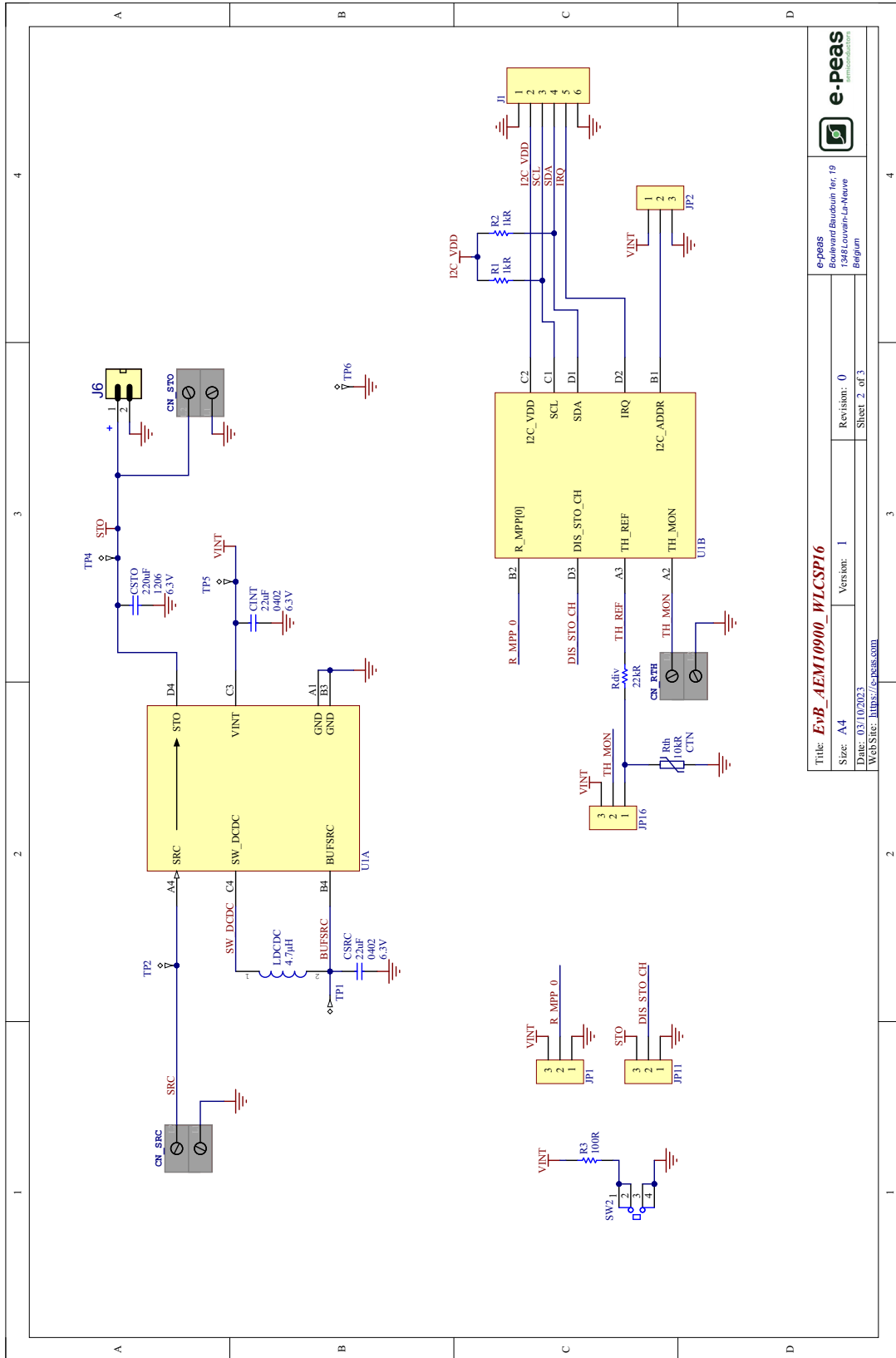


Figure 3: AEM10900 Evaluation Board Schematic

<p>e-peas semiconductors</p>	
<p>Title: EvB_AEM10900_WLCSP16</p>	
<p>Size: A4</p>	<p>Revision: 0</p>
<p>Date: 03/10/2023</p>	<p>Version: 1</p>
<p>WebSite: https://e-peas.com</p>	
<p>Address: Boulevard Baudouin 169 1348 Louvain-La-Neuve Belgium</p>	
<p>Sheet 2 of 3</p>	

7. Revision History

EVK Version	User Guide Revision	Date	Description
1.0	0.9	February, 2022	Creation of the document.
1.0	1.0	September, 2023	Fixed some inconsistencies and updated images.
1.0	1.1	February, 2024	Fixed some inconsistencies.

Table 6: Revision History